

8-Bit Single-Chip Microcontroller

Preliminary

Overview

The LC863532/28/24/20/16A are 8-bit single chip microcontrollers with the following on-chip functional blocks:

- CPU : Operable at a minimum bus cycle time of 0.424µs
- On-chip ROM capacity

Program ROM: 32K/28K/24K/20K/16K bytes

CGROM: 16K bytes

- On-chip RAM capacity: 512 bytes
- OSD RAM: 352×9 bits
- Closed-Caption TV controller and the on-screen display controller
- Four channels × 6-bit AD Converter
- Three channels × 7-bit PWM
- Two channels × 16-bit timer/counter, 14-bit base timer
- IIC-bus compliant serial interface circuit (Multi-master type)
- ROM correction function
- 12-source 8-vectored interrupt system
- Integrated system clock generator and display clock generator

Only one X'tal oscillator (32.768kHz) for PLL reference is used for both generators

TV control and the Closed Caption function

All of the above functions are fabricated on a single chip.

Note: This product includes the IIC bus interface circuit. If you intend to use the IIC bus interface, please notify us of this in advance of our receiving your program ROM code order.

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Features

(1) Read-Only Memory (ROM) : 32768×8 bits $/ 28672 \times 8$ bits $/ 24576 \times 8$ bits 20486×8 bits $/ 16384 \times 8$ bits for program

 20486×8 bits / 16384×8 bits for progr 16128×8 bits for CGROM

(2) Random Access Memory (RAM): 384 × 8 bits (working area)

 128×8 bits (working or ROM correction function)

 352×9 bits (for CRT display)

(3) OSD functions

- Screen display : 36 characters × 16 lines (by software)

- RAM : 352 words (9 bits per word)

Display area : $36 \text{ words} \times 8 \text{ lines}$ Control area : $8 \text{ words} \times 8 \text{ lines}$

- Characters

Up to 252 kinds of 16×32 dot character fonts

(4 characters including 1 test character are not programmable)

Each font can be divided into two parts and used as two fonts (Ex. 16×16 dot character font $\times 2$)

At least 111 characters need to be divide between a 16×18 dot and 8×9 dot character font to display the caption fonts.

- Various character attributes

Rounding Underline

Italic character (slanting)

- Attribute can be changed without spacing
- Vertical display start line number can be set for each row independently (Rows can be overlapped)
- Horizontal display start position can be set for each row independently
- Horizontal pitch (bit 9 16)*1 and vertical pitch (bit-32) can be set for each row independently
- Different display modes can be set for each row independently

Caption • Text mode / OSD mode 1 / OSD mode 2 (Quarter size) / Simplified graphic mode

- Ten character sizes *1

Horez.
$$\times$$
 Vert. = (1×1) , (1×2) , (2×2) , (2×4) , (0.5×0.5)
 (1.5×1) , (1.5×2) , (3×2) , (3×4) , (0.75×0.5)

- Shuttering and scrolling on each row
- Simplified Graphic Display
- *1 Note: range depends on display mode: refer to the manual for details.

(4) Bus Cycle Time / Instruction-Cycle Time

Bus cycle time	Instruction cycle time	Clock divider	System clock oscillation	Oscillation Frequency	Voltage
0.424μs	0.848µs	1/2	Internal VCO	14.156MHz	4.5V to 5.5V
			(Ref : X'tal 32.768kHz)		
7.5µs	15.0µs	1/2	Internal RC	800kHz	4.5V to 5.5V
91.55μs	183.1µs	1/1	Crystal	32.768kHz	4.5V to 5.5V
183.1µs	366.2µs	1/2	Crystal	32.768kHz	4.5V to 5.5V

(5) Ports

- Input / Output Ports : 4 ports (24 terminals)
Data direction programmable in nibble units : 1 port (8 terminals)

(If the N-ch open drain output is selected by option, the corresponding port data can be read in output mode.)

Data direction programmable for each bit individually : 3 ports (16 terminals)

(6) AD converter

- 4 channels × 6-bit AD converters

(7) Serial interfaces

- IIC-bus compliant serial interface (Multi-master type)

Consists of a single built-in circuit with two I/O channels. The two data lines and two clock lines can be connected internally.

(8) PWM output

- 3 channels × 7-bit PWM

(9) Timer

- Timer 0: 16-bit timer/counter

With 2-bit prescaler + 8-bit programmable prescaler

Mode 0: Two 8-bit timers with a programmable prescaler

Mode 1: 8-bit timer with a programmable prescaler + 8-bit counter

Mode 2: 16-bit timer with a programmable prescaler

Mode 3: 16-bit counter

The resolution of timer is 1 tCYC.

- Timer 1: 16-bit timer/PWM

Mode 0: Two 8-bit timers

Mode 1:8-bit timer + 8-bit PWM

Mode 2: 16-bit timer

Mode 3: a variable-bit PWM (9 to 16 bits)

In mode 0/1, the resolution of timer/PWM is 1 tCYC

In mode 2/3, the resolution of timer/PWM is selectable by program; tCYC or 1/2 tCYC

- Base timer

Generate every 500ms overflow for a clock application (using 32.768kHz crystal oscillation for the base timer clock) Generate every 976µs, 3.9ms, 15.6ms, 62.5ms overflow (using 32.768kHz crystal oscillation for the base timer clock)

Clock for the base timer is selectable from 32.768kHz crystal oscillation, system clock or programmable prescaler output of Timer 0

(10) Remote control receiver circuit (connected to the P73/INT3/T0IN terminal)

- Noise rejection function
- Polarity switching

(11) Watchdog timer

External RC circuit is required

Interrupt or system reset is activated when the timer overflows

(12) ROM correction function

Max 128 bytes / 2 addresses

(13) Interrupts

- 12 sources 8 vectored interrupts
 - 1. External Interrupt INTO
 - 2. External Interrupt INT1
 - 3. External Interrupt INT2, Timer/counter T0L (Lower 8 bits)
 - 4. External Interrupt INT3, base timer
 - 5. Timer/counter T0H (Upper 8 bits)
 - 6. Timer T1H, Timer T1L
 - 7. Vertical synchronous signal interrupt (\overline{VS}), horizontal line (\overline{HS})
 - 8. IIC
- Interrupt priority control

Three interrupt priorities are supported (low, high and highest) and multi-level nesting is possible. Low or high priority can be assigned to the interrupts from 3 to 8 listed above. For the external interrupt INTO and INT1, low or highest priority can be set.

(14) Sub-routine stack level

- A maximum of 128 levels (stack is built in the internal RAM)

(15) Multiplication/division instruction

- 16 bits \times 8 bits (7 instruction cycle times)
- 16 bits / 8 bits (7 instruction cycle times)

(16) 3 oscillation circuits

- Built-in RC oscillation circuit used for the system clock
- Built-in VCO circuit used for the system clock and OSD
- X'tal oscillation circuit used for base timer, system clock and PLL reference

(17) Standby function

- HALT mode

The HALT mode is used to reduce the power dissipation. In this operation mode, the program execution is stopped. This mode can be released by the interrupt request or the system reset.

- HOLD mode

The HOLD mode is used to stop the oscillations; RC (internal), VCO, and X'tal oscillations. This mode can be released by the following conditions.

- Pull the reset terminal (\overline{RES}) to low level.
- Feed the selected level to either P70/INT0 or P71/INT1.

(18) Package

- MFP36S
- DIP36S

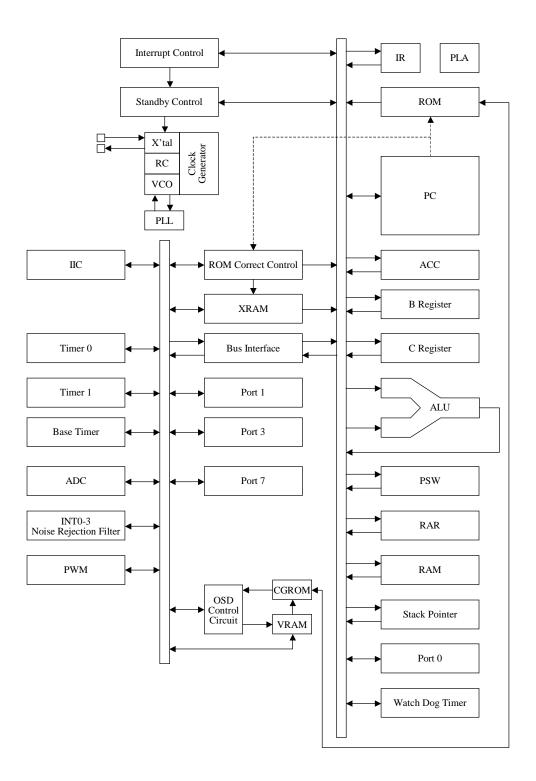
(19) Development tools

- Flash EEPROM: LC86F3548A- Evaluation chip: LC863096

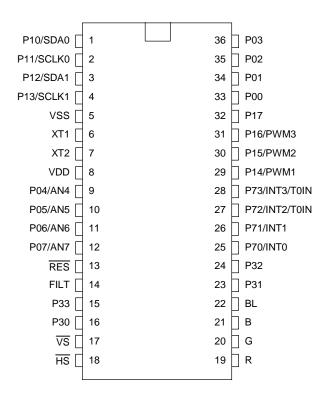
- Emulator: EVA86000 (main) + ECB863400 (evaluation chip board)

+ POD36-CABLE (cable) + POD36-DIP (for DIP36S) or POD36-MFP (for MFP36S)

System Block Diagram

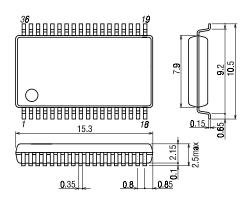


Pin Assignment



Package Dimension

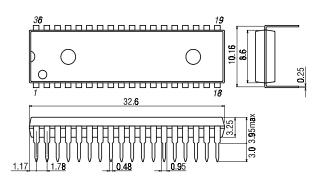
(unit : mm) 3204



SANYO: MFP-36S

Package Dimension

(unit : mm) 3170



SANYO: DIP-36S

Pin Description

Pin Description Table

Terminal	I/O	Function Description	Option
VSS	-	Negative power supply	
XT1	I	Input terminal for crystal oscillator	
XT2	О	Output terminal for crystal oscillator	
VDD	-	Positive power supply	
RES	I	Reset terminal	
FILT	О	Filter terminal for PLL	
VS	I	Vertical synchronization signal input terminal	
HS	I	Horizontal synchronization signal input terminal	
R	0	Red (R) output terminal of RGB image output	
G	О	Green (G) output terminal of RGB image output	
В	О	Blue (B) output terminal of RGB image output	
BL	О	Fast blanking control signal Switch TV image signal and caption/OSD image signal	
Port 0 P00 to P07	I/O	Note that the New York of	Pull-up resistor provided/not provided Output Format CMOS/Nch-OD
Port 1 P10 to P17	I/O	*8-bit input/output port Input/output can be specified for each bit (programmable pull-up resister provided) *Other functions P10 IIC0 data I/O P11 IIC0 clock output P12 IIC1 data I/O P13 IIC1 clock output P14 PWM1 output P15 PWM2 output P16 PWM3 output P17 Timer 1 (PWM) output	Output Format CMOS/Nch-OD
Port 3 P30 to P33	I/O	•4-bit input/output port Input/output can be specified for each bit (CMOS output/input with programmable pull-up resister)	

Terminal	I/O			Functi	on Descri	ption			Option
Port 7		•4-bit in	put/outpu	t port					
P70	I/O	Input of	or output	an be spec	cified for e	each bit			
P71 to P73		P70:	I/O with 1	orogramma	able pull-u	ıp resister)	
		P71 t	o P73: CI	MOS outp	ut/input w	ith progra	mmable p	ull-up	
		resist	ter)	
		•Other f	unction						
		P	70 INT	0 input/H	OLD relea	se input/			
			Nch	-Tr. outpu	t for wach	idog timer	•		
		P	71 INT	1 input/H	OLD relea	se input			
		P	72 INT	2 input/Ti	mer 0 eve	nt input			
		P	73 INT	3 input (noi	se rejection	filter conn	nected)/		
			Tim	er 0 event	input				
		Interrup	t receiver	format, ve	ector addre	esses			
			rising	falling	rising/	H level	L level	vector	
					falling				
		INT0	enable	enable	disable	enable	enable	03H	
		INT1	enable	ble enable disable enable enable OBH					
		INT2	enable	enable	enable	disable	disable	13H	
		INT3	enable	enable	enable	disable	disable	1BH	

Note: A capacitor of at least $10\mu F$ must be inserted between VDD and VSS when using this IC.

- Output form and existance of pull-up resistor for all ports can be specified for each bit.
- Programmable pull-up resistor is always connected regardless of port option, CMOS or N-ch open drain output in port 1.
- Port status in reset

Terminal	I/O	Pull-up resistor status at selecting CMOS output option
Port 0	I	Pull-up resistor OFF, ON after reset release
Port 1	I	Programmable pull-up resistor OFF

1. Absolute Maximum Ratings at VSS=0V and Ta=25°C

Doro	meter	Symbol	Pins	Conditions			Ratings		unit
raia	meter	Symbol	FIIIS	Conditions	VDD[V]	min.	typ.	max.	uiiit
Supply v	oltage	VDDMAX	VDD			-0.3		+7.0	V
Input vo	ltage	VI(1)	• RES , HS , VS , CVIN			-0.3		VDD+0.3	
Output v	oltage	VO(1)	R, G, B, BL, FILT			-0.3		VDD+0.3	
Input/ou voltage	tput	VIO	•Ports 0, 1, 3, 7			-0.3		VDD+0.3	
High level	Peak output	IOPH(1)	•Ports 0, 1, 3, 7	•CMOS output •For each pin.		-4			mA
output current	current	IOPH(2)	R, G, B, BL	•CMOS output •For each pin.		-5			
	Total output	∑IOAH(1)	Ports 0, 1	The total of all pins.		-20			
	current	∑IOAH(2)	Ports 3, 7	The total of all pins.		-10			
		∑IOAH(3)	R, G, B, BL	The total of all pins.		-12			
Low	Peak	IOPL(1)	Ports 0, 1, 3	For each pin.				20	
level	output	IOPL(2)	Port 7	For each pin.				15	
output	current	IOPL(3)	R, G, B, BL	For each pin.				5	
current	Total output	∑IOAL(1)	Ports 0, 1	The total of all pins.				40	
	current	ΣIOAL(2)	Ports 3, 7	The total of all pins.				20	
		∑IOAL(3)	R, G, B, BL	The total of all pins.				12	
Maximu	m power	Pdmax	MFP36S	Ta=-10 to +70°C				340	mW
dissipation			DIP36S					500	
Operatin temperat range	_	Topg				-10		+70	°C
Storage temperat range	ure	Tstg				-55		+125	

2. Recommended Operating Range at Ta=-10°C to +70°C, VSS=0V

Parameter	Symbol	Pins	Conditions			Ratings		unit
1 at atticted	Symbol	L IIIS	Colluitions	VDD[V]	min.	typ.	max.	uiiit
Operating supply voltage	VDD(1)	VDD	0.844μs ≤ tCYC ≤ 0.852μs		4.5		5.5	V
range	VDD(2)		4μs ≤ tCYC ≤ 400μs		4.5		5.5	
Hold voltage	VHD	VDD	RAMs and the registers data are kept in HOLD mode.		2.0		5.5	
High level input voltage	VIH(1)	Port 0	Output disable	4.5 to 5.5	0.6VDD		VDD	
	VIH(2)	•Ports 1,3 (Schumitt) •Port 7 (Schumitt) port input/interrupt • HS, VS, RES (Schumitt)	Output disable	4.5 to 5.5	0.75VDD		VDD	
	VIH(3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	VDD-0.5		VDD	
Low level	VIL(1)	Port 0	Output disable	4.5 to 5.5	VSS		0.2VDD]
input voltage	VIL(2)	•Ports 1,3 (Schumitt) •Port 7 (Schumitt) port input/interrupt • HS, VS, RES (Schumitt)	Output disable	4.5 to 5.5	VSS		0.25VDD	
	VIL(3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	VSS		0.6VDD	
Operation cycle time	tCYC(1)		•All functions operating	4.5 to 5.5	0.844	0.848	0.852	μs
	tCYC(2)		•AD converter operating •OSD is not operating	4.5 to 5.5	0.844		30	
	tCYC(3)		•OSD, AD converter is not operating	4.5 to 5.5	0.844		400	
Oscillation frequency range	FmRC		Internal RC oscillation	4.5 to 5.5	0.4	0.8	3.0	MHz

3. Electrical Characteristics at Ta=-10°C to +70°C, VSS=0V

Parameter	Symbol	Pins	Conditions			Ratings		unit
Tarameter	Symbol	1 1115	Conditions	VDD[V]	min.	typ.	max.	uiiit
High level input current	IIH(1)	Ports 0, 1, 3, 7	•Output disable •Pull-up MOS Tr. OFF •VIN=VDD (including the off-leak current of the output Tr.)	4.5 to 5.5			1	μА
	IIH(2)	• RES • HS , VS	•VIN=VDD	4.5 to 5.5			1	
Low level input current	IIL(1)	Ports 0, 1, 3, 7	•Output disable •Pull-up MOS Tr. OFF •VIN=VSS (including the off-leak current of the output Tr.)	4.5 to 5.5	-1			
	IIL(2)	• RES • HS , VS	VIN=VSS	4.5 to 5.5	-1			
High level output voltage	VOH(1)	•CMOS output of ports 0,1,3,71-73	IOH=-1.0mA	4.5 to 5.5	VDD-1			V
	VOH(2)	R, G, B, BL	IOH=-0.1mA R.G.B: digital mode	4.5 to 5.5	VDD-0.5			
Low level	VOL(1)	Ports 0,1,3,71-73	IOL=10mA	4.5 to 5.5			1.5	
output voltage	VOL(2)	Ports 0,3,71-73	IOL=1.6mA	4.5 to 5.5			0.4	
	VOL(3)	•R, G, B, BL •Port 1	IOL=3.0mA R.G.B: digital mode	4.5 to 5.5			0.4	
	VOL(4)	Port 70	IOL=1mA	4.5 to 5.5			0.4	
Pull-up MOS Tr. resistance	Rpu	•Ports 0, 1, 3, 7	VOH=0.9VDD	4.5 to 5.5	13	38	80	kΩ
Bus terminal short circuit resistance (SCL0-SCL1, SDA0-SDA1)	RBS	•P10-P12 •P11-P13		4.5 to 5.5			130	Ω
Hysteresis voltage	VHIS	•Ports 1, 3, 7 • RES • HS, VS	Output disable	4.5 to 5.5		0.1VDD		V
Pin capacitance	СР	All pins	•f=1MHz •Every other terminals are connected to VSS. •Ta=25°C	4.5 to 5.5		10		pF

4. IIC Input/Output Conditions at Ta=-10 $^{\circ}$ C to +70 $^{\circ}$ C, VSS=0V

Parameter	Symbol	Stan	dard	High	High speed		
Farameter	Symbol	min.	max.	min.	max.	unit	
SCL Frequency	fSCL	0	100	0	400	kHz	
BUS free time between stop - start	tBUF	4.7	-	1.3	-	μs	
HOLD time of start, restart condition	tHD;STA	4.0	-	0.6	-	μs	
L time of SCL	tLOW	4.7	-	1.3	-	μs	
H time of SCL	tHIGH	4.0	-	0.6	-	μs	
Set-up time of restart condition	tSU;STA	4.7	-	0.6	-	μs	
HOLD time of SDA	tHD;DAT	0	-	0	0.9	μs	
Set-up time of SDA	tSU;DAT	250	-	100	-	ns	
Rising time of SDA, SCL	tR	-	1000	20+0.1Cb	300	ns	
Falling time of SDA, SCL	tF	-	300	20+0.1Cb	300	ns	
Set-up time of stop condition	tSU;STO	4.0	-	0.6	-	μs	

Refer to figure 7

(Note) Cb: Total capacitance of all BUS (unit: pF)

5. Pulse Input Conditions at Ta=-10°C to +70°C, VSS=0V

Parameter	Symbol	Pins	Conditions			Ratings		unit
r ai ailletei	Symbol	FIIIS	Conditions	VDD[V]	min.	typ.	max.	umi
High/low level pulse width	tPIH(1) tPIL(1)	•INT0, INT1 •INT2/T0IN	•Interrupt acceptable •Timer0-countable	4.5 to 5.5	1			tCYC
	tPIH(2) tPIL(2)	INT3/T0IN (1 tCYC is selected for noise rejection clock.)	•Interrupt acceptable •Timer0-countable	4.5 to 5.5	2			
	tPIH(3) tPIL(3)	INT3/T0IN (16 tCYC is selected for noise rejection clock.)	•Interrupt acceptable •Timer0-countable	4.5 to 5.5	32			
	tPIH(4) tPIL(4)	INT3/T0IN (64 tCYC is selected for noise rejection clock.)	•Interrupt acceptable •Timer0-countable	4.5 to 5.5	128			
	tPIL(5)	RES	Reset acceptable	4.5 to 5.5	200			μs
	tPIH(6) tPIL(6)	HS, VS	Display position controllable (Note) The active edge of HS and VS must be apart at least 1 tCYC. Refer to figure 6.	4.5 to 5.5	8			
Rising/falling time	tTHL tTLH	HS	Refer to figure 6.	4.5 to 5.5			500	ns

6. AD Converter Characteristics at Ta=-10°C to + 70°C, VSS=0V

Parameter	Symbol	Pins	Conditions			Ratings		unit
Parameter	Syllibol	Pills	Collations	VDD[V]	min.	typ.	max.	uiiit
Resolution	N			4.5 to 5.5		6		bit
Absolute precision	ET		(Note)				±1	LSB
Conversion time	tCAD	Vref selection to conversion finish	1 bit conversion time = 2 × Tcyc			1.69		μs
Analog input voltage range	VAIN	AN4 - AN7			VSS		VDD	V
Analog port	IAINH		VAIN=VDD				1	μΑ
input current	IAINL		VAIN=VSS		-1			

(Note) Absolute precision does not include quantizing error (1/2LSB).

7. Analog Mode RGB Characteristics at Ta=-10°C to +70°C, VSS=0V

Parameter	er Symbol Pins		Conditions				unit	
Faranietei	Symbol	Filis	Conditions	VDD[V]	min.	typ.	max.	umt
Analog output		R.G.B	Low level output	5.0	0.45	0.5	0.55	V
voltage		Analog output mode	Intensity output		0.90	1.0	1.10	
			Hi lebel output		1.35	1.5	1.65	
Time setting		R.G.B	70%				50	ns
			10pf load					

8. Sample Current Dissipation Characteristics at Ta=-10°C to +70°C, VSS=0V

The sample current dissipation characteristics is the measurement result of Sanyo provided evaluation board when the recommended circuit parameters shown in the sample oscillation circuit characteristics are used externally. The currents through the output transistors and the pull-up MOS transistors are ignored.

Parameter	Symbol	Pins	Conditions			Ratings		unit
1 drameter	Symbol		Conditions	VDD[V]	min.	typ.	max.	umt
Current dissipation during basic operation (Note 3)	IDDOP(1)	VDD	•FmX'tal=32.768kHz X'tal oscillation •System clock: VCO •VCO for OSD operating •OSD is Digital mode •Internal RC oscillation stops	4.5 to 5.5		14	25	mA
	IDDOP(2)	VDD	•FmX'tal=32.768kHz X'tal oscillation •System clock: VCO •VCO for OSD operating •OSD is Analog mode •Internal RC oscillation stops	4.5 to 5.5		23	37	
	IDDOP(3)	VDD	•FmX'tal=32.768kHz X'tal oscillation •System clock: X'tal •VCO for system VCO for OSD, internal RC oscillation stop •Data slicer, AD converters stop	4.5 to 5.5		100	300	μА
Current dissipation in HALT mode (Note 3)	IDDHALT(1)	VDD	•HALT mode •FmX'tal=32.768kHz X'tal oscillation •System clock: VCO •VCO for OSD stops •Internal RC oscillation stops	4.5 to 5.5		5	10	mA
	IDDHALT(2)		•HALT mode •FmX'tal=32.768kHz X'tal oscillation •VCO for system stops •VCO for OSD stops •System clock: Internal RC	4.5 to 5.5		360	1000	μА
	IDDHALT(3)	VDD	•HALT mode •FmX'tal=32.768kHz X'tal oscillation •VCO for system stops •VCO for OSD stops •System clock: X'tal	4.5 to 5.5		40	200	
Current dissipation in HOLD mode (Note 3)	IDDHOLD	VDD	•HOLD mode •All oscillation stops.	4.5 to 5.5		0.05	20	μА

(Note 3) The currents through the output transistors and the pull-up MOS transistors are ignored.

Recommended Oscillation Circuit and Sample Characteristics

The sample oscillation circuit characteristics in the table below is based on the following conditions:

- Recommended circuit parameters are verified by an oscillator manufacturer using a Sanyo provided oscillation evaluation board.
- Sample characteristics are the result of the evaluation with the recommended circuit parameters connected externally.

Recommended oscillation circuit and sample characteristics ($Ta = -10 \text{ to } +70^{\circ}\text{C}$)

Frequency	Manufacturer	Oscillator	Recommended circuit parameters			Operating supply voltage range	Oscillation stabilizing time		Notes	
			C1	C2	Rf	Rd		typ.	max	
32.768kHz	Seiko Epson	C-002RX	18pF	18pF	open	390kΩ	4.5 to 5.5V	1.00S	1.50S	

Notes The oscillation stabilizing time period is the time until the VCO oscillation for the internal system becomes stable after the following conditions. (Refer to Figure 2.)

- 1. The VDD becomes higher than the minimum operating voltage after the power is supplied.
- 2. The HOLD mode is released.

The sample oscillation circuit characteristics may differ applications. For further assistance, please contact with oscillator manufacturer with the following notes in your mind.

- Since the oscillation frequency precision is affected by wiring capacity of the application board, etc., adjust the oscillation frequency on the production board.
- The above oscillation frequency and the operating supply voltage range are based on the operating temperature of -10°C to +70°C. For the use with the temperature outside of the range herein, or in the applications requiring high reliability such as car products, please consult with oscillator manufacturer.
- When using the oscillator which is not shown in the sample oscillation circuit characteristics, please consult with Sanyo sales personnel.

Since the oscillation circuit characteristics are affected by the noise or wiring capacity because the circuit is designed with low gain in order to reduce the power dissipation, refer to the following notices.

- The distance between the clock I/O terminal (XT1 terminal XT2 terminal) and external parts should be as short as possible.
- The capacitors' VSS should be allocated close to the microcontroller's GND terminal and be away from other GND.
- The signal lines with rapid state changes or with large current should be allocated away from the oscillation circuit.

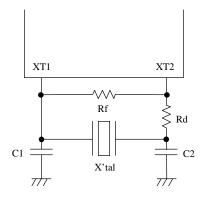


Figure 1 Recommended oscillation circuit.

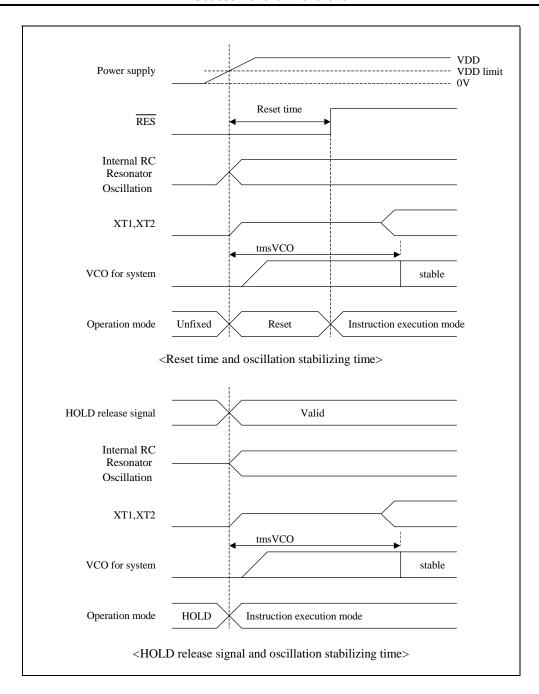


Figure 2 Oscillation stabilizing time

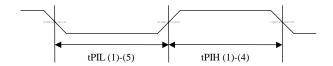


Figure 3 Pulse input timing condition – 1

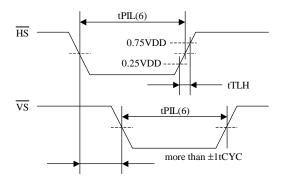


Figure 4 Pulse input timing condition - 2

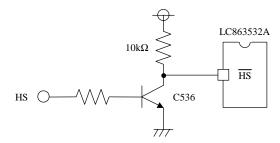


Figure 5 Recommended Interface circuit

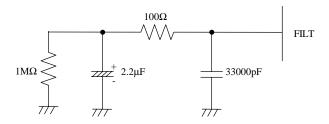
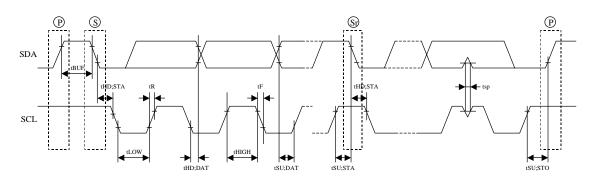


Figure 6 FILT recommended circuit

(Note) Place FILT parts on board as close to the microcontroller as possible.



S : start condition
P : stop condition
Sr : restart condition

tsp: Spike suppression

Standard mode : not exist High speed mode : less than 50ns

Figure 7 IIC timing

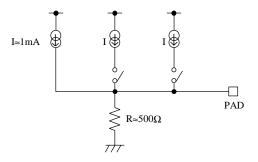


Figure 8 R.G.B. analog output equivalent circuit

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